



Dear Customer:

Shelf Life: Silicon Labs has reviewed the available data and applicable standards and has concluded that parts which are packed/repacked in accordance to J-STD-033, will not degrade with respect to solderability 2 years from the ship date. Upon opening the package, the Humidity Indicator Card (HIC) should be inspected and if HIC indicates maximum humidity has been exceeded, product should be rebaked per IPC/JEDEC J-STD-033. If the HIC does not indicate a need for re-baking, it is safe to reflow components per the product MSL rating.

Date Code Policy: Silicon Labs manufacturing date code has no impact on the functionality, quality, or reliability of our products. The minimum useful life and warranty of the product begins on the date of delivery to the customer, not the manufacturing date code.

Warranty period: 2 years from ship date for solderability related issue. All others, see standard terms and conditions

As always, Silicon Labs will honor the standard terms and conditions in terms of product quality and reliability. Should you have any further questions, please contact Silicon Labs Sales for assistance.

Best Regards,

James Ong
Quality Engineering Director
Silicon Labs, Inc.